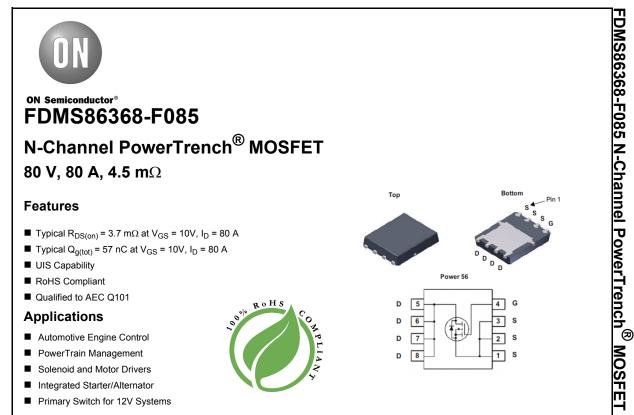
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MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		80	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	80		
	Pulsed Drain Current	T _C = 25°C	See Figure 4	Α	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	82	mJ	
P _D	Power Dissipation		214	W	
	Derate Above 25°C		1.43	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.7	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W	

Notes:

1: Current is limited by bondwire configuration.

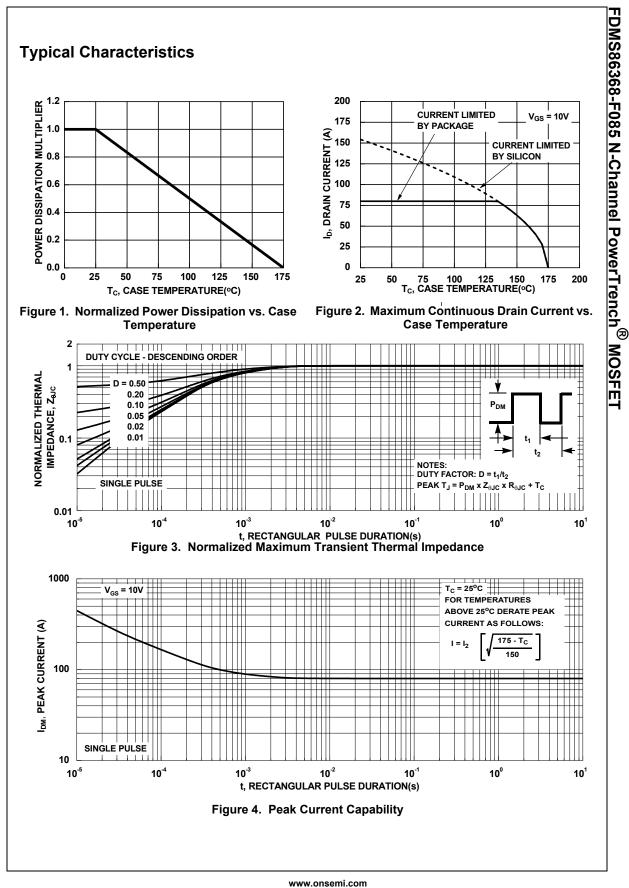
2: Starting $T_J = 25^{\circ}$ C, L = 40uH, $I_{AS} = 64$ A, $V_{DD} = 80$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

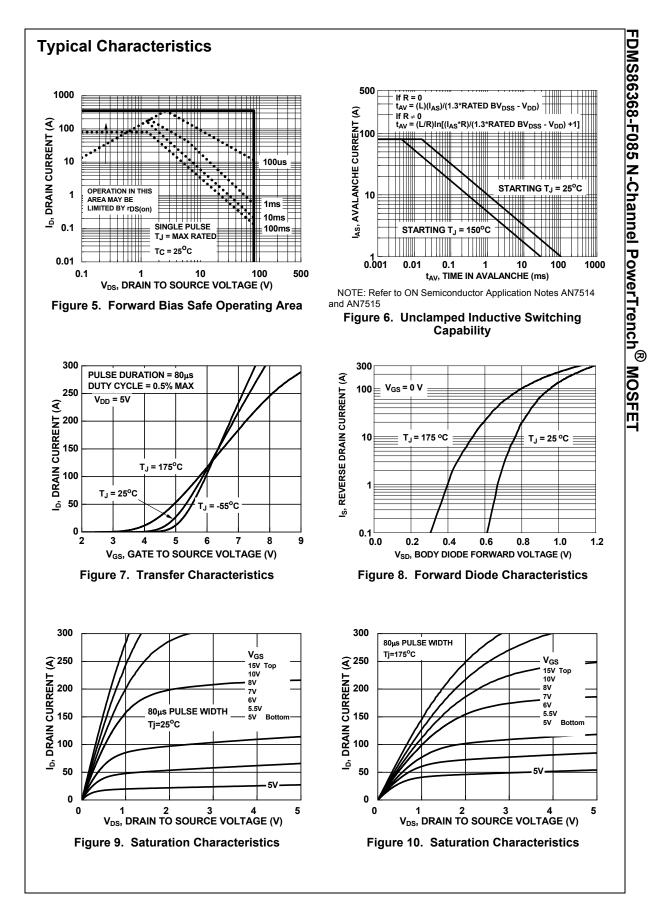
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

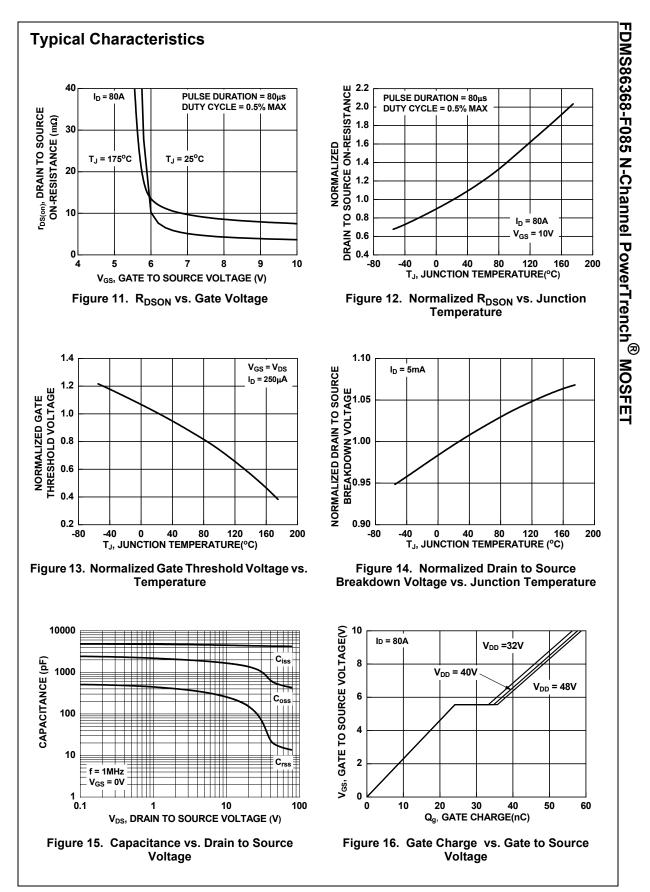
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86368	FDMS86368-F085	Power56	13"	12mm	3000units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, '	V _{GS} =0V	80	-	-	V
_		V _{DS} =80V		-	-	1	μA
I _{DSS}	Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J} = 175^{\rm o}C$ (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA		2.0	3.0	4.0	V
	Drain to Source On Registence	I _D = 80A,	$T_J = 25^{\circ}C$	-	3.7	4.5	mΩ
R _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V	$T_{\rm J}$ = 175°C (Note 4)	-	7.4	9.0	mΩ
Dynami	ic Characteristics						
C _{iss}	Input Capacitance	$V_{DS} = 40V, V_{GS} = 0V,$ f = 1MHz f = 1MHz V_{GS} = 0 to 10V V_{DD} = 64V		-	4350	-	pF
C _{oss}	Output Capacitance			-	636	-	pF
C _{rss}	Reverse Transfer Capacitance			-	20	-	pF
R _q	Gate Resistance			-	2.5	-	Ω
Q _{g(ToT)}	Total Gate Charge			-	57	75	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to 2	$V I_D = 80A$	-	8	-	nC
Q _{gs}	Gate-to-Source Gate Charge			-	23	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	11	-	nC
Switchi	ng Characteristics			_	-	60	ns
t _{d(on)}	Turn-On Delay		Ť	-	23	-	ns
t _r	Rise Time	$V_{DD} = 40V, I_D = 80A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		-	22	-	ns
t _{d(off)}	Turn-Off Delay			-	32	-	ns
t _f	Fall Time			-	13	-	ns
t _{off}	Turn-Off Time			-	-	59	ns
Drain-S	ource Diode Characteristics						
	Source-to-Drain Diode Voltage	I _{SD} =80A, V _{GS} = 0V		-	-	1.25	V
V _{SD}		I _{SD} = 40A, V _{GS} = 0V		-	-	1.2	V
	Reverse-Recovery Time	$I_{F} = 80A, dI_{SD}/dt = 100A/\mu s$		-	58 49	75 67	ns nC
V _{SD} t _{rr} Q _{rr}	Reverse-Recovery Charge	$\lambda = c \Delta t$	$V_{DD} = 64V$				





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